

METHOD FOR ELECTROLESS PLATING A CONTACT PAD

Tongbi Jiang et al.

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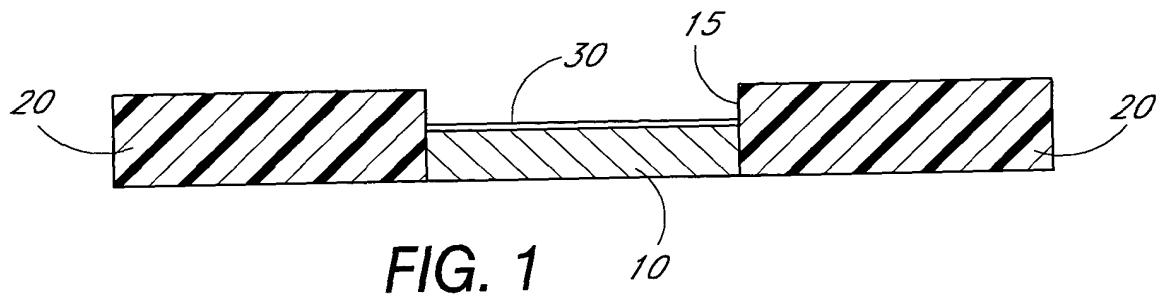


FIG. 1

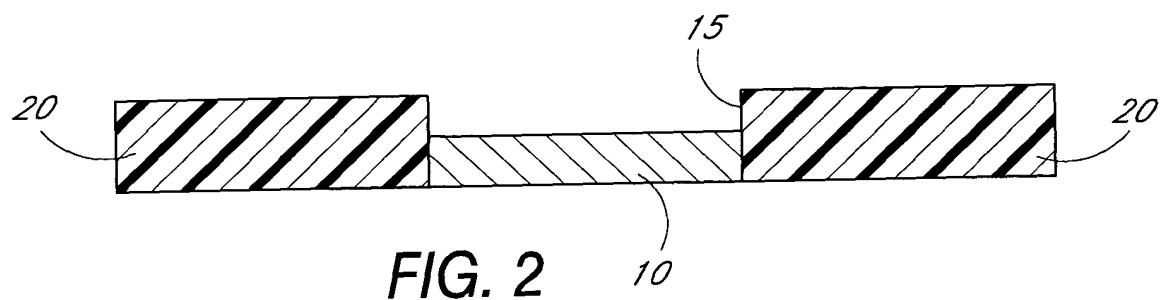


FIG. 2

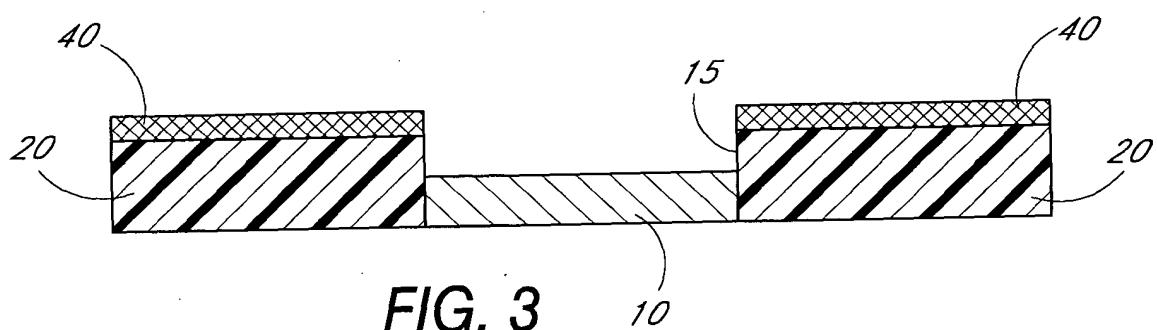


FIG. 3

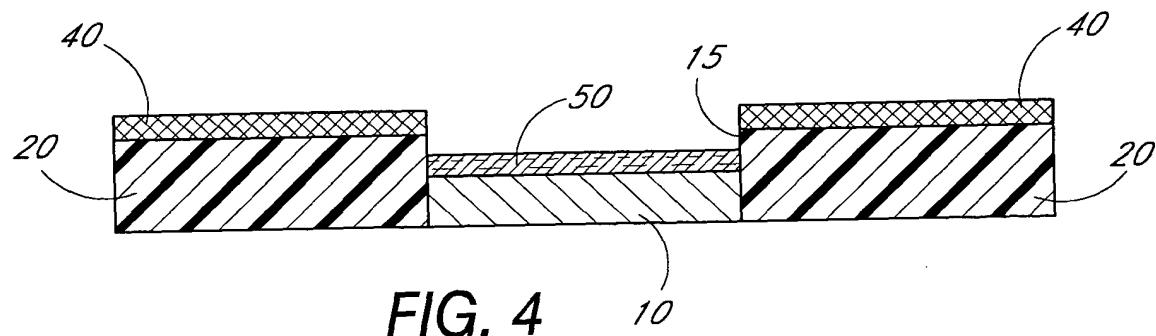


FIG. 4

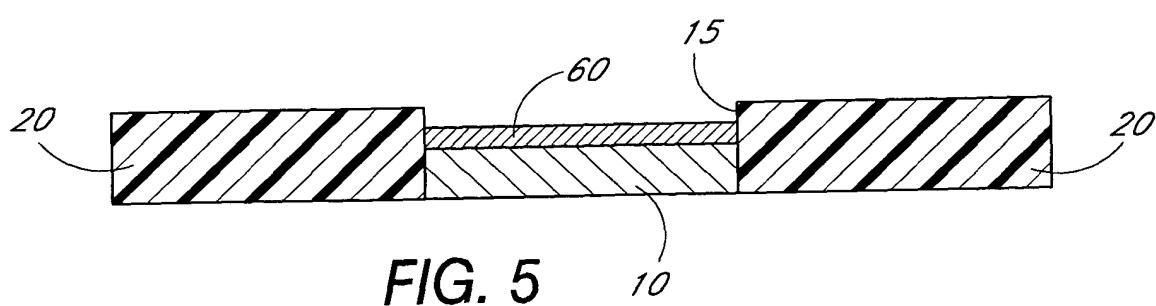


FIG. 5

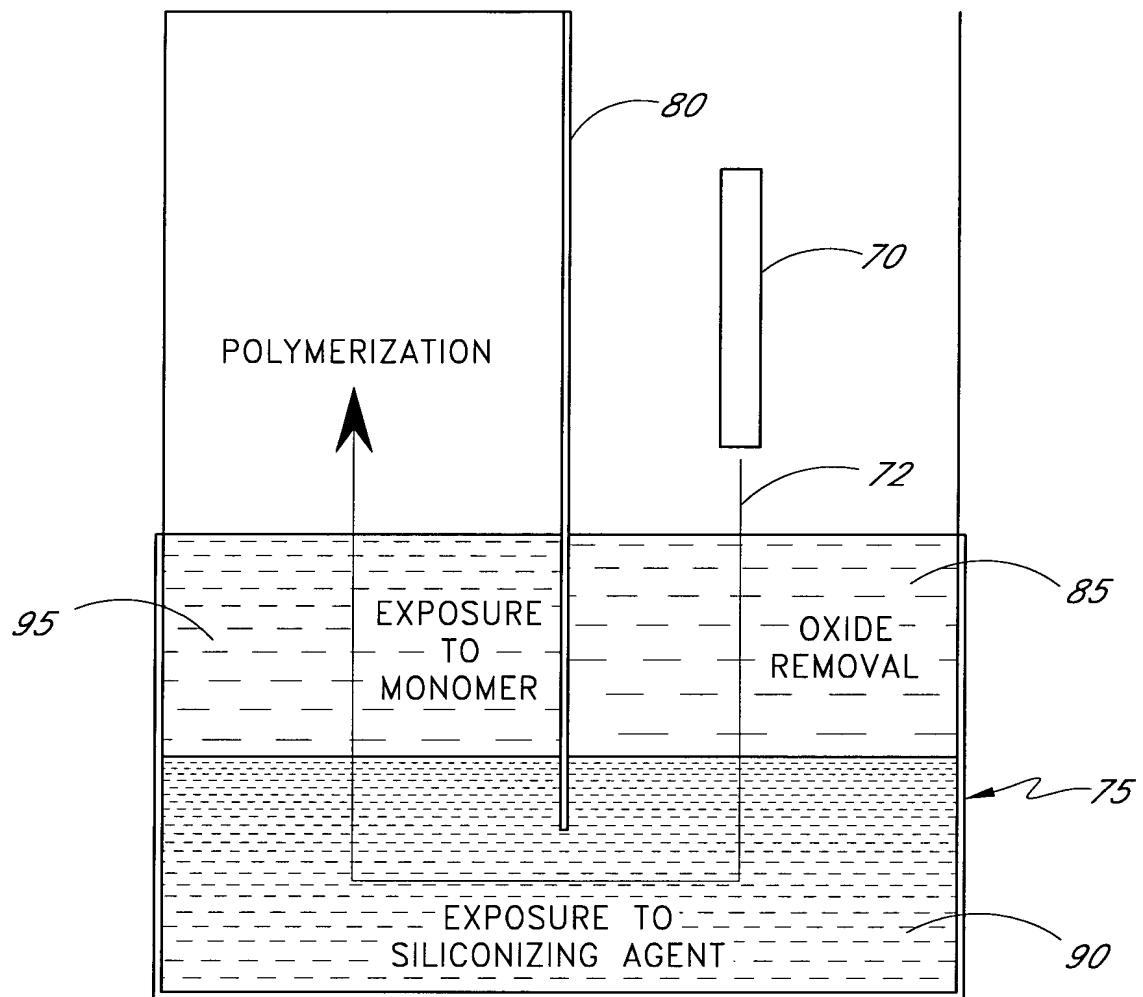


FIG. 6